

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
Kazuhiko KUSUNOKI	04/12/2013
Kazuhito KAMEI	04/12/2013
Nobuyoshi YASHIRO	04/12/2013
Kouji MORIGUCHI	04/12/2013
Nobuhiro OKADA	04/12/2013
Katsunori DANNO	04/10/2013
Hironori DAIKOKU	04/10/2013

**RECEIVING PARTY DATA**

<b>Name:</b>	NIPPON STEEL & SUMITOMO METAL CORPORATION
<b>Street Address:</b>	6-1, Marunouchi 2-chome, Chiyoda-ku,
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	100-8071

<b>Name:</b>	TOYOTA JIDOSHA KABUSHIKI KAISHA
<b>Street Address:</b>	1, Toyota-cho, Toyota-shi,
<b>City:</b>	Aichi-ken
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	471-8571

**PROPERTY NUMBERS Total: 1**

Property Type	Number
<b>Application Number:</b>	13883350

**CORRESPONDENCE DATA**

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**PATENT**  
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Date:	05/03/2013

Total Attachments: 6  
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**ASSIGNMENT**

This is an Assignment of the following rights, title and interest:

- United States of America rights, title and interest in the invention
- Foreign rights, title and interest in the invention
- International Application No. PCT/JP2011/075483
- Date of Filing: November 4, 2011
- For which an application for a U.S. Patent was executed on \_\_\_\_\_
- United States Patent Application Serial No. \_\_\_\_\_
- Date of Filing: \_\_\_\_\_

Title of the Invention: **METHOD FOR MANUFACTURING N-TYPE SiC SINGLE CRYSTAL**

Inventors (Assignors): **Kazuhiko KUSUNOKI, Kazuhito KAMEI, Nobuyoshi YASHIRO, Kouji MORIGUCHI, Nobuhiro OKADA, Katsunori DANNO, and Hironori DAIKOKU**

Assignee(s): **NIPPON STEEL & SUMITOMO METAL CORPORATION**  
 6-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8071 JAPAN

**TOYOTA JIDOSHA KABUSHIKI KAISHA**  
 1, Toyota-cho, Toyota-shi, Aichi-ken 471-8571 Japan

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said applications(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States, unto said Assignee.

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

*Kazuhiko Kusunoki*  
 \_\_\_\_\_  
 Signature: **Kazuhiko KUSUNOKI**

April 12, 2013  
 \_\_\_\_\_  
 Date

*Kazuhito Kamei*  
 \_\_\_\_\_  
 Signature: **Kazuhito KAMEI**

April 12, 2013  
 \_\_\_\_\_  
 Date

Nobuyoshi Yashiro  
Signature: **Nobuyoshi YASHIRO**

April 12, 2013  
Date

\_\_\_\_\_  
Signature: **Kouji MORIGUCHI**

\_\_\_\_\_  
Date

\_\_\_\_\_  
Signature: **Nobuhiro OKADA**

\_\_\_\_\_  
Date

\_\_\_\_\_  
Signature: **Katsunori DANNO**

\_\_\_\_\_  
Date

\_\_\_\_\_  
Signature: **Hironori DAIKOKU**

\_\_\_\_\_  
Date

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Inventors (Assignors): **Kazuhiko KUSUNOKI, Kazuhito KAMEI, Nobuyoshi YASHIRO, Kouji MORIGUCHI, Nobuhiro OKADA, Katsunori DANNO, and Hironori DAIKOKU**

Assignee(s): **NIPPON STEEL & SUMITOMO METAL CORPORATION**  
 6-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8071 JAPAN

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\_\_\_\_\_  
 Signature: **Kazuhiko KUSUNOKI**

\_\_\_\_\_  
 Date

\_\_\_\_\_  
 Signature: **Kazuhito KAMEI**

\_\_\_\_\_  
 Date

Signature: Nobuyoshi YASHIRO

*Kouji Moriguchi*  
Signature: Kouji MORIGUCHI

*Nobuhiro Okada*  
Signature: Nobuhiro OKADA

Signature: Katsunori DANNO

Signature: Hironori DAIKOKU

Date

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Docket No:

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Signature: **Kazuhiko KUSUNOKI**

\_\_\_\_\_ Date

Signature: **Kazuhito KAMEI**

\_\_\_\_\_ Date

Signature: **Nobuyoshi YASHIRO**

Date

Signature: **Kouji MORIGUCHI**

Date

Signature: **Nobuhiro OKADA**

Date

*Katsunori Danno*  
Signature: **Katsunori DANNO**

April 10, 2013  
Date

*Hironori Daikoku*  
Signature: **Hironori DAIKOKU**

April 10, 2013  
Date